

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: SMS7621-081LF

Manufacturer: Skyworks Solutions Inc.

Package: 6-TSSOP, SC-88, SOT-363

Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/skyworks-solutions-inc/sms7621-081lf.html>

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Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

DATA SHEET

Surface Mount Mixer and Detector Schottky Diodes

Applications

- Sensitive RF and microwave detector circuits
- Sampling and mixer circuits
- High-volume wireless
- WiFi and mobile
- Low-noise receivers in high-sensitivity ID tags
- Radio designs

Features

- Tight parameter distribution
- Available as singles, pairs, and dual pairs
- Packages rated MSL1, 260 °C per JEDEC J-STD-020



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.



Description

These low-cost, surface mountable, plastic packaged silicon mixer Schottky diodes are designed for RF and microwave mixers and detectors. They include low barrier diodes and zero-bias detectors that combine Skyworks advanced semiconductor technology with low-cost packaging techniques. All diodes are 100 percent DC tested and deliver tight parameter distribution, which minimizes performance variability.

These diodes are available in SOD-882, SC-79, SOT-23, and Molded Interconnect System (MIS) packages. Wiring configurations include singles, common cathode, series pairs, unconnected pairs, and dual series pairs. They may be used at frequencies up to 24 GHz.

Table 1 describes the various packages and marking of the mixer and detector Schottky diodes.

Table 1. Schottky Diode Packaging and Marking

					
Single	Single	Series Pair	Reverse Series Pair	Unconnected Pair	Single
SC-79 Green™	SOT-23	SOT-23	SOT-23	MIS Green™	SOD-882 Green™
				SMS7621-517 Marking: H Pb-Free	
◆ SMS7621-079LF Marking: Cathode and SA	SMS7621-001LF Green™ Marking: XH1	◆ SMS7621-005LF Green™ Marking: XH2	◆ SMS7621-006LF Green™ Marking: XH8		SMS7621-040LF Marking: E
◆ SMS7630-079LF Marking: Anode and SC		SMS7630-005LF Green™ Marking: XD2	◆ SMS7630-006LF Green™ Marking: XD8		SMS7630-040LF Marking: P
$L_S = 0.7 \text{ nH}$	$L_S = 1.5 \text{ nH}$	$L_S = 1.5 \text{ nH}$	$L_S = 1.5 \text{ nH}$	$L_S = 0.6 \text{ nH}$	$L_S = 0.45 \text{ nH}$



The Pb-free symbol or "LF" in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

Electrical and Mechanical Specifications

The absolute maximum ratings of the mixer and detector Schottky diodes are provided in Table 2. Electrical specifications are provided in Tables 3 and 4. The associated SPICE model parameters are provided in Table 5. A typical detector schematic diagram is shown in Figure 1.

Typical performance characteristics are illustrated in Figures 2 and 3. Package dimensions are shown in Figures 4 to 10 (even numbers), and tape and reel dimensions are provided in Figures 5 to 11 (odd numbers).

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The mixer and detector Schottky diodes are rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C for 5 seconds. They can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 2. Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Reverse voltage	V_R		Rated V_B	V
Forward current, steady state	I_F		50	mA
Power dissipation	P_D		75	mW
Storage temperature	T_{STG}	−65	+150	°C
Operating temperature	T_A	−65	+150	°C
Junction temperature	T_J		+150	°C

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

Table 3. Electrical Specifications¹

($T_A = +25\text{ °C}$ Per Junction, Unless Otherwise Noted)

Part Number	Barrier	Minimum V_B @ 10 μA (V)	Typical C_T @ 0 V (pF)	V_F @ 1 mA (mV)	Maximum Pair Configuration ΔV_F @ 1 mA (mV)	Maximum R_T ² (Ω)
SMS7621 series	Low	2	0.25	260 to 320	10	18 @ 5 mA

¹ Performance is guaranteed only under the conditions listed in this table.

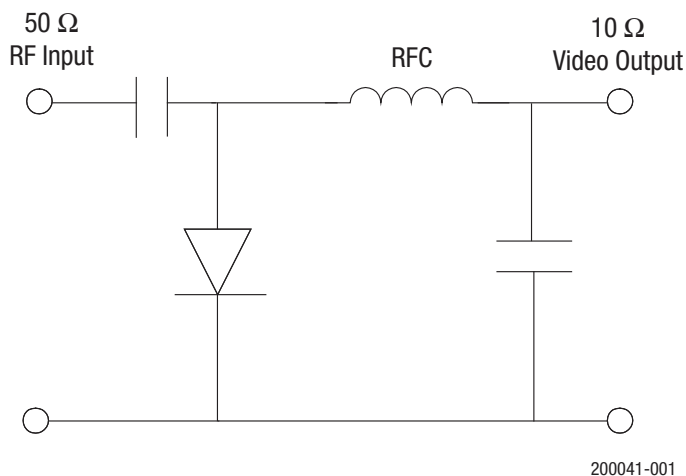
² R_T is the slope resistance.

Table 4. Electrical Specifications¹**(T_A = +25 °C Per Junction, Unless Otherwise Noted)**

Part Number	Minimum V _B @ 100 μ A (V)	Typical C _T @ 0.15 V (pF)	V _F @ 0.1 mA (mV)	V _F @ 1 mA (mV)	Maximum Pair Configuration Δ V _F @ 1 mA (mV)	Typical R _v (Ω)
SMS7630 series	1	0.3	60 to 120	135 to 240	10	5000

¹ Performance is guaranteed only under the conditions listed in this table.**Table 5. SPICE Model Parameters (Per Junction)**

Parameter	Units	SMS7621 Series	SMS7630 Series
I _S	A	4E-8	5E-6
R _S	Ω	12	20
N	–	1.05	1.05
T _T	sec	1E-11	1E-11
C _{J0}	pF	0.1	0.14
M	–	0.35	0.40
E _G	eV	0.69	0.69
X _{TI}	–	2	2
F _C	–	0.5	0.5
B _V	V	3	2
I _{BV}	A	1E-5	1E-4
V _J	V	0.51	0.34

**Figure 1. Typical Detector Circuit**

Typical Performance Characteristics

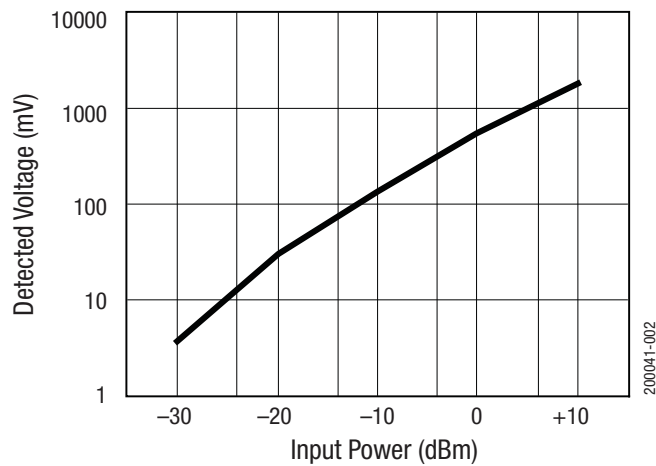


Figure 2. Typical Detector Characteristics @ 1.8 GHz

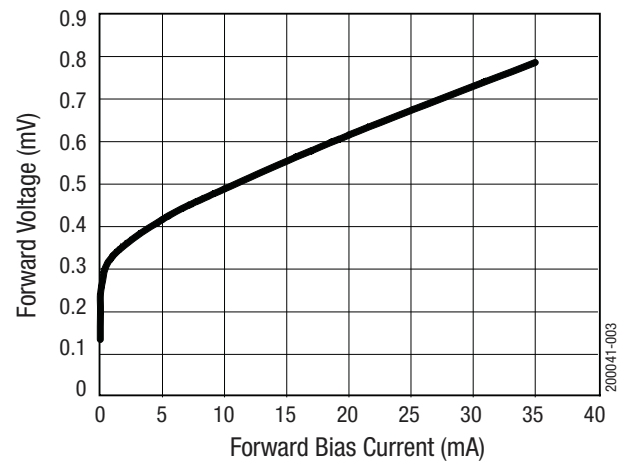
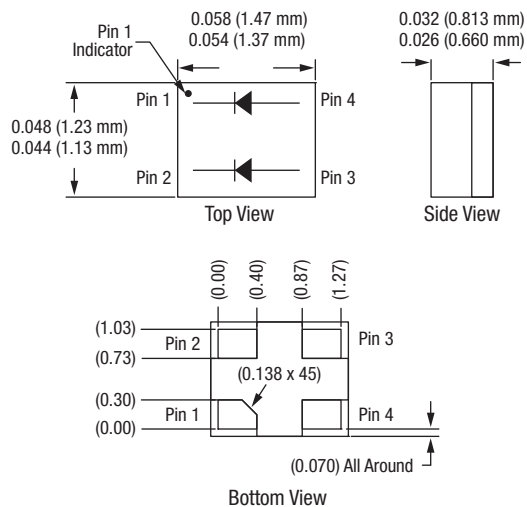


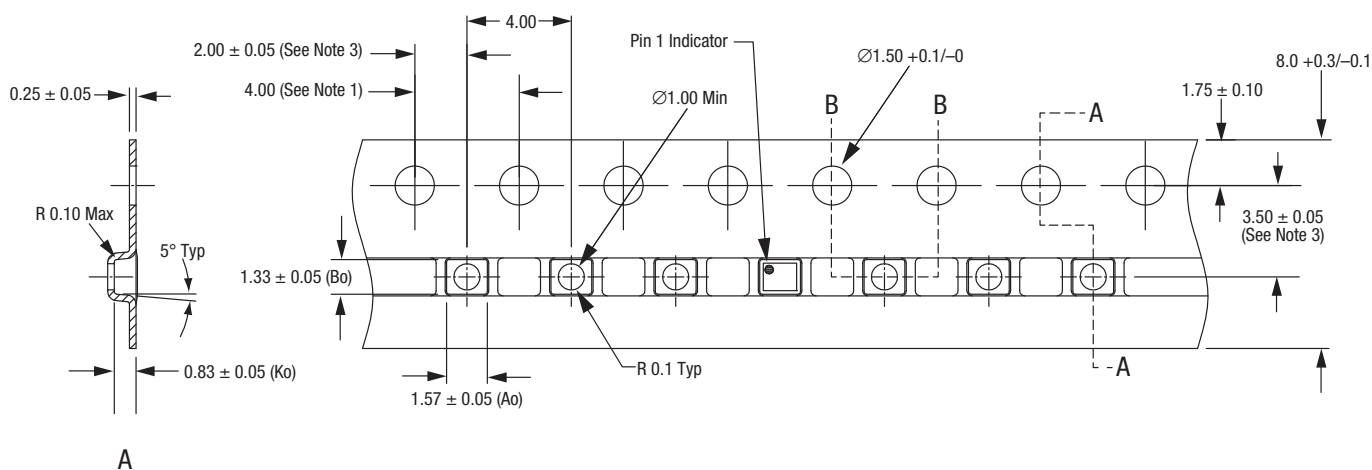
Figure 3. SMS7621 Forward Voltage vs Forward Bias Current



Dimensions are in inches (millimeters shown in parentheses)

200041-004

Figure 4. MIS Package Dimension Drawing

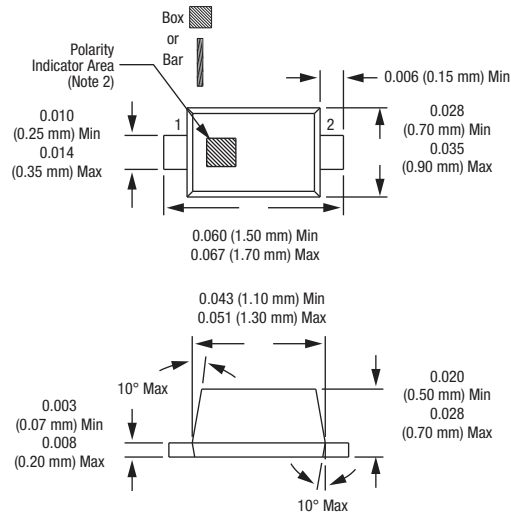


Notes:

1. 10-sprocket hole pitch cumulative tolerance ± 0.2 mm.
2. Carrier tape: black conductive polycarbonate or polystyrene.
3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
4. ESD-surface resistivity is $\leq 1 \times 10^8$ Ohms/square per EIA, JEDEC TNR Specification.
5. Cover tape material: transparent conductive PSA with 5.4 mm width.
6. All measurements are in millimeters.

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Figure 5. MIS Tape and Reel Dimensions

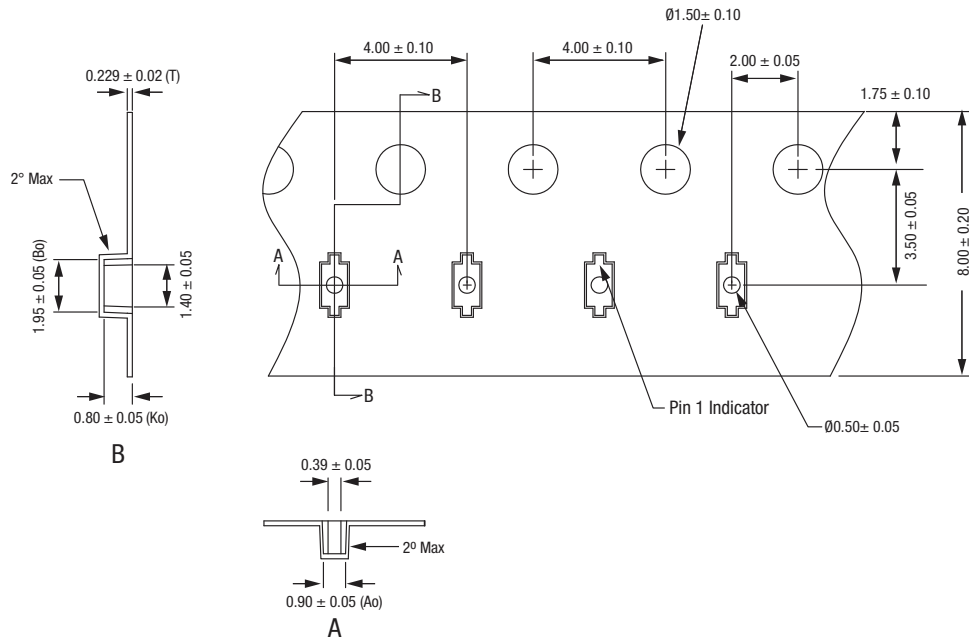


Notes:

1. Dimensions are in inches (millimeters shown in parentheses).
2. Cathode indicator for SMS7621-079LF
Anode indicator for SMS7630-079LF

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Figure 6. SC-79 Package Dimension Drawing

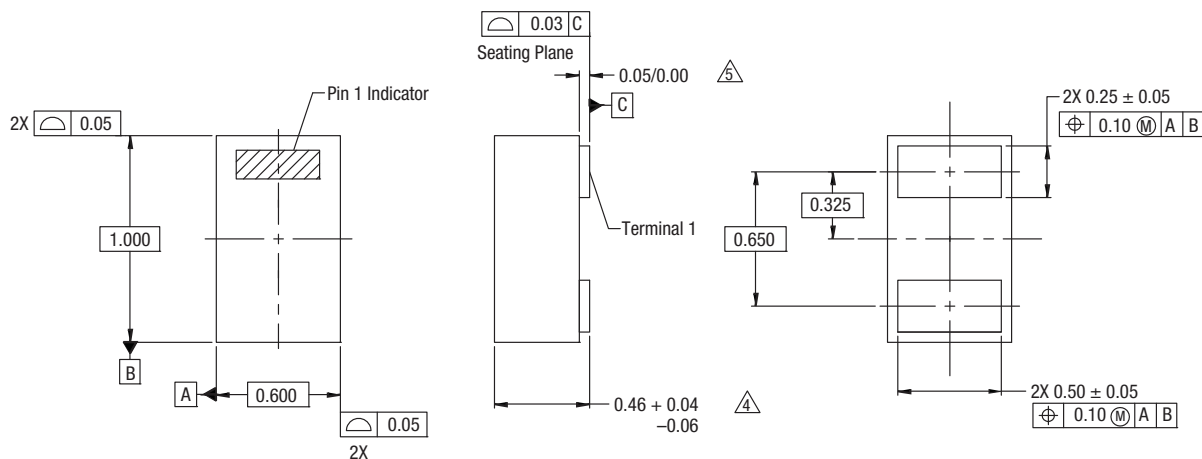


Notes:

1. Carrier tape: black conductive polycarbonate or polystyrene.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.4 mm width.
4. ESD-surface resistivity is $\leq 1 \times 10^8$ Ohms/square per EIA, JEDEC TNR Specification.
5. All measurements are in millimeters.

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Figure 7. SC-79 Tape and Reel Dimensions

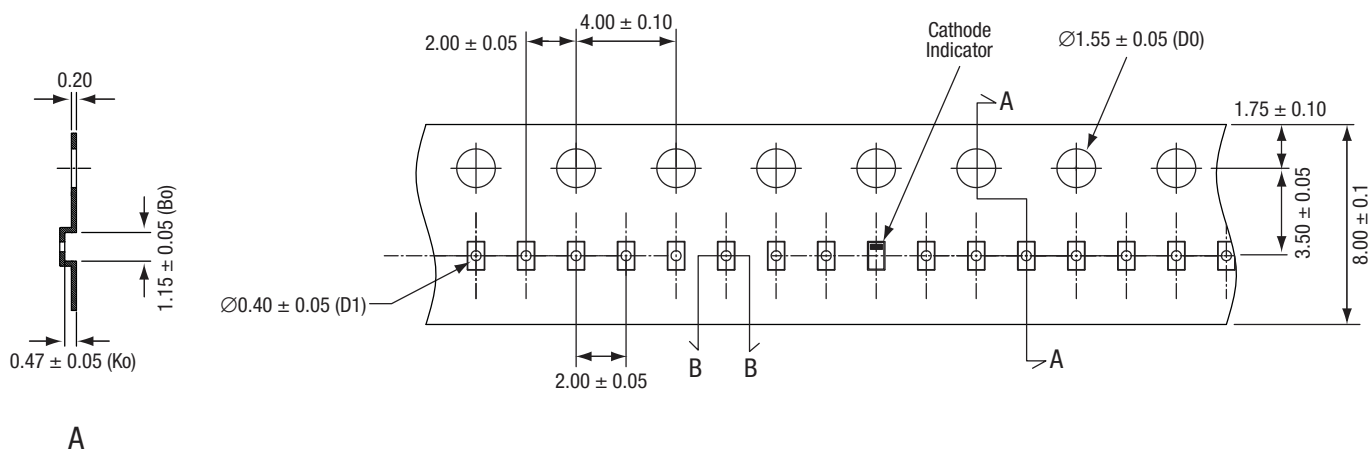


Notes:

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. These packages are used principally for discrete devices.
4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
5. This dimension is primarily terminal plating, but does not include small metal protrusion.

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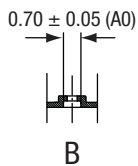
Figure 8. SOD-882 Package Dimension Drawing



A

Notes:

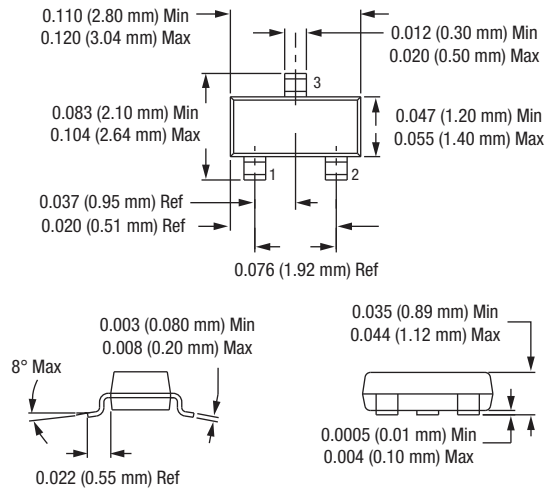
1. Carrier tape: black conductive polycarbonate.
2. Cover tape: transparent conductive material.
3. Cover tape size: 5.4 mm width.
4. ESD surface resistivity is $\geq 1 \times 10^4 \sim 1 \times 10^8$ Ohms/square.
5. All dimensions are in millimeters.



B

200041-009

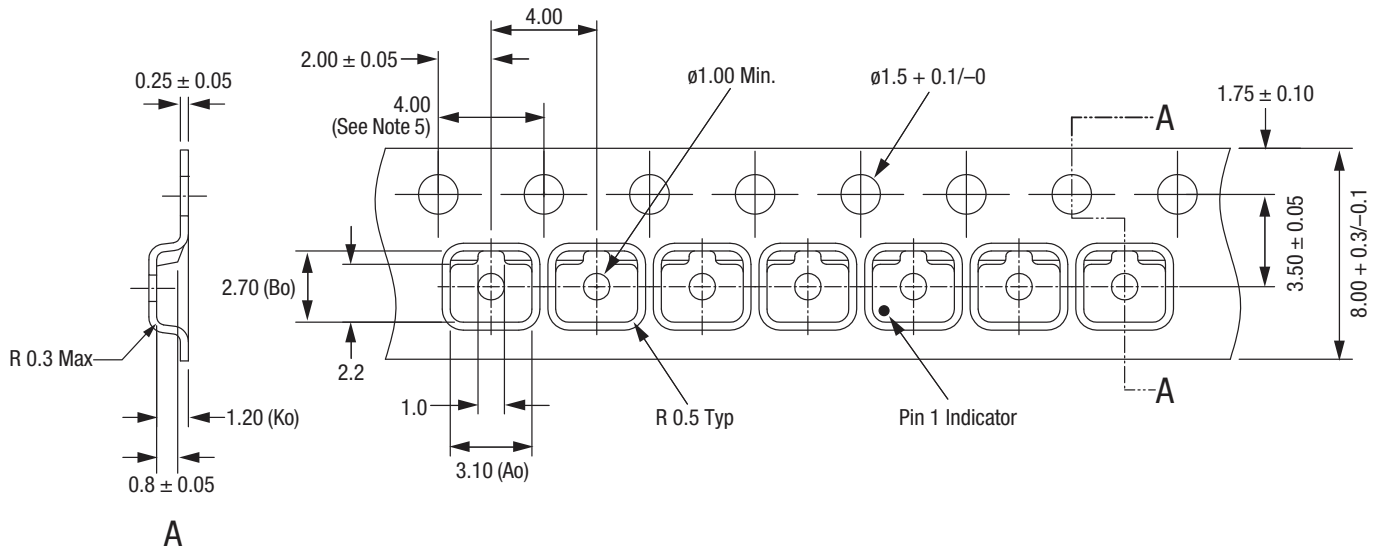
Figure 9. SOD-882 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses)

200041-010

Figure 10. SOT-23 Package Dimension Drawing



Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape material: transparent conductive PSA.
3. Cover tape size: 5.40 mm width.
4. Tolerance ± 0.10 mm.
5. Ten sprocket hole pitch cumulative tolerance: ± 0.2 mm.
6. All measurements are in millimeters.
7. Alternative carrier tape dimensions are:
 $A_o = 3.3$
 $B_o = 2.9$
 $K_o = 1.22$

200041-011

Figure 11. SOT-23 Tape and Reel Dimensions

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